

Features

- Zero Reverse Recovery Current
- Zero Forward Recovery Voltage
- Positive Temperature Coefficient on V_F
- Temperature-independent Switching
- 175°C Operating Junction Temperature

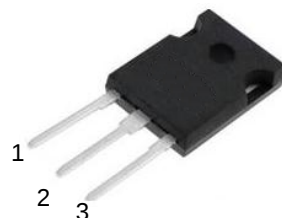
V_{RRM}	=	650	V
$I_F (T_C \leq 135^\circ\text{C})$	=	52	A**
Q_C	=	80	nC**

*Per Leg, **Per Device

Benefits

- Replace Bipolar with Unipolar Device
- Reduction of Heat Sink Size
- Parallel Devices Without Thermal Runaway
- Essentially No Switching Losses

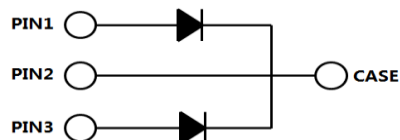
Package



TO-247-3

Applications

- Switch Mode Power Supplies
- Power Factor Correction
- Motor drive, PV Inverter, Wind Power Station



Part Number	Package	Marking
AS3D040065P2	TO-247-3	ASD4065P2

Maximum Ratings

Symbol	Parameter	Value	Unit	Test Conditions	Note
V_{RRM}	Repetitive Peak Reverse Voltage	650	V	$T_C = 25^{\circ}\text{C}$	
V_{RSM}	Surge Peak Reverse Voltage	650	V	$T_C = 25^{\circ}\text{C}$	
V_R	DC Blocking Voltage	650	V	$T_C = 25^{\circ}\text{C}$	
I_F	Forward Current (Per leg/Device)	57/114 26/52 20/40	A	$T_C \leq 25^{\circ}\text{C}$ $T_C \leq 135^{\circ}\text{C}$ $T_C \leq 148^{\circ}\text{C}$	
I_{FSM}	Non-Repetitive Forward Surge Current	170*	A	$T_C = 25^{\circ}\text{C}$, $t_p = 8.3\text{ms}$, Half Sine Wave	
P_{tot}	Power Dissipation (Per leg/Device)	187/ 374	W	$T_C = 25^{\circ}\text{C}$	Fig.3
T_C	Maximum Case Temperature	148	$^{\circ}\text{C}$		
T_J, T_{STG}	Operating Junction and Storage Temperature	-55 to 175	$^{\circ}\text{C}$		
	TO-247 Mounting Torque	1	Nm	M3 Screw	

Electrical Characteristics (Per Leg)

Symbol	Parameter	Typ.	Max.	Unit	Test Conditions	Note
V_F	Forward Voltage	1.4 1.75	1.65 2.3	V	$I_F = 20\text{A}$, $T_J = 25^{\circ}\text{C}$ $I_F = 20\text{A}$, $T_J = 175^{\circ}\text{C}$	Fig.1
I_R	Reverse Current	1 5	20 100	μA	$V_R = 650\text{V}$, $T_J = 25^{\circ}\text{C}$ $V_R = 650\text{V}$, $T_J = 175^{\circ}\text{C}$	Fig.2
C	Total Capacitance	1190 115 96	/	pF	$V_R = 0\text{V}$, $T_J = 25^{\circ}\text{C}$, $f = 1\text{MHz}$ $V_R = 200\text{V}$, $T_J = 25^{\circ}\text{C}$, $f = 1\text{MHz}$ $V_R = 400\text{V}$, $T_J = 25^{\circ}\text{C}$, $f = 1\text{MHz}$	Fig.5
Q_C	Total Capacitive Charge	40	/	nC	$V_R = 650\text{V}$, $I_F = 20\text{A}$ $di/dt = 200\text{A}/\mu\text{s}$, $T_J = 25^{\circ}\text{C}$	Fig.4

Thermal Characteristics

Symbol	Parameter	Typ.	Unit	Note
$R_{\theta JC}$	Thermal Resistance from Junction to Case	0.8* 0.4**	$^{\circ}\text{C}/\text{W}$	Fig.6
$R_{\theta JA}$	Thermal Resistance from Junction to Ambient	80	$^{\circ}\text{C}/\text{W}$	
T_{sold}	Soldering Temperature	260	$^{\circ}\text{C}$	

*Per Leg, **Per Device

Typical Performance (Per Leg)

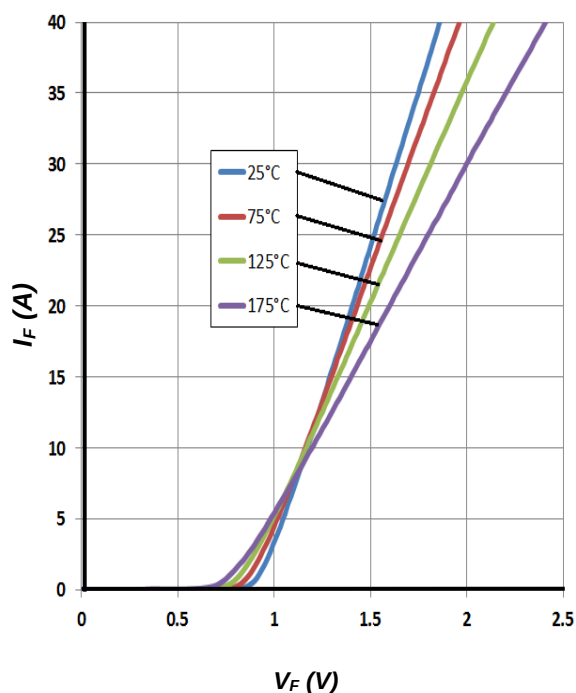


Figure 1. Forward Characteristics

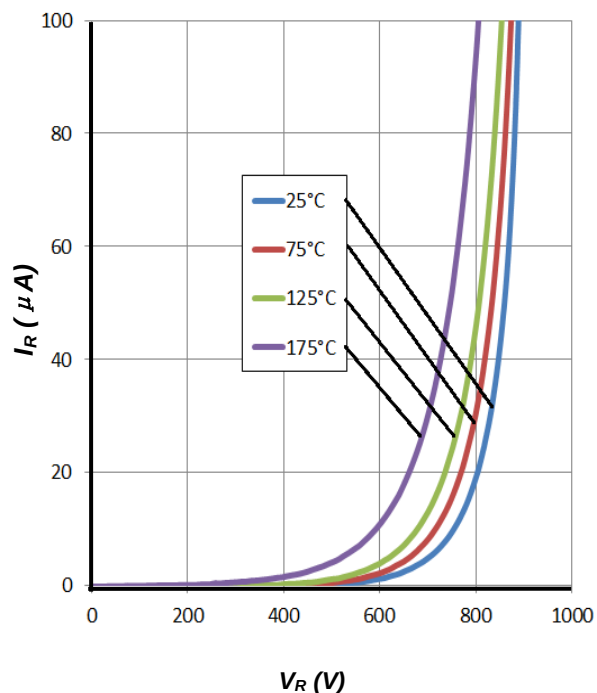


Figure 2. Reverse Characteristics

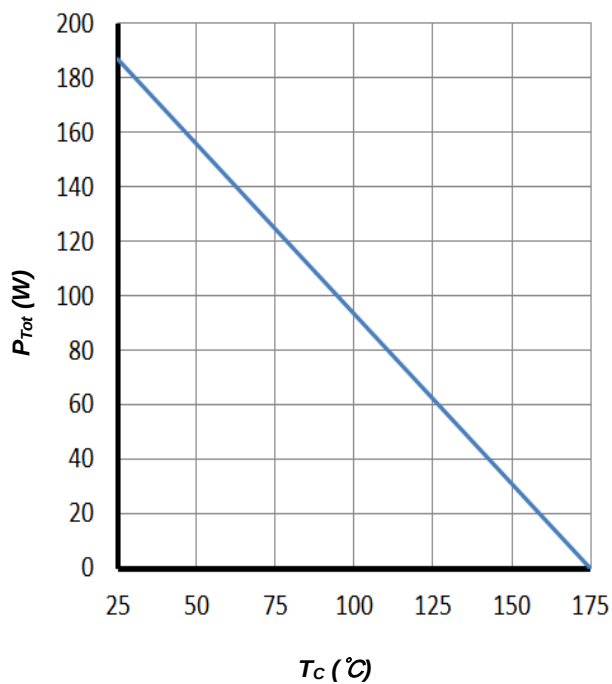


Figure 3. Power Derating

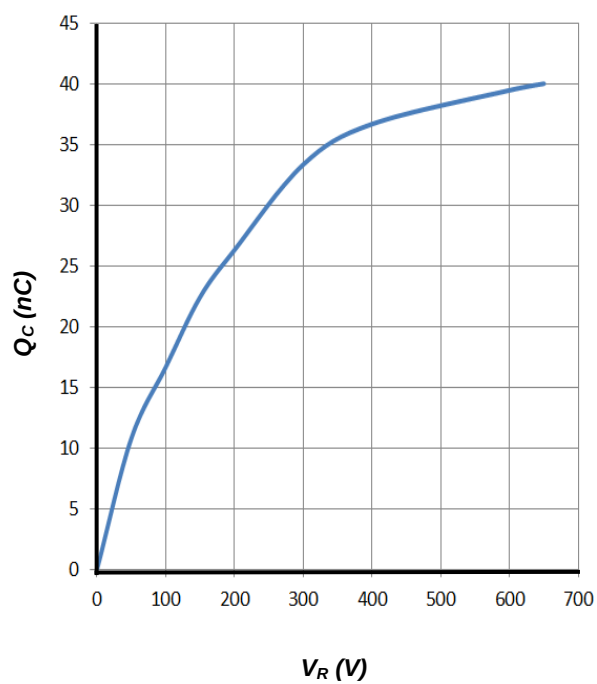


Figure 4. Total Capacitive Charge vs. Reverse Voltage

Typical Performance (Per Leg)

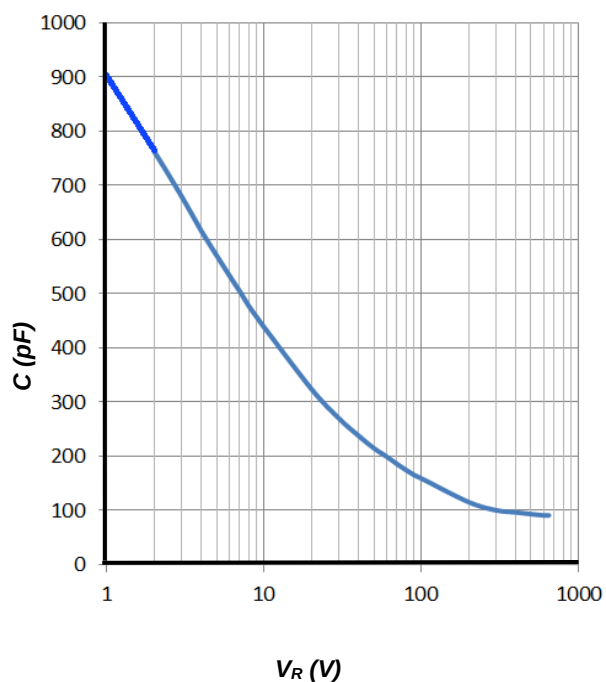


Figure 5. Total Capacitance vs. Reverse Voltage

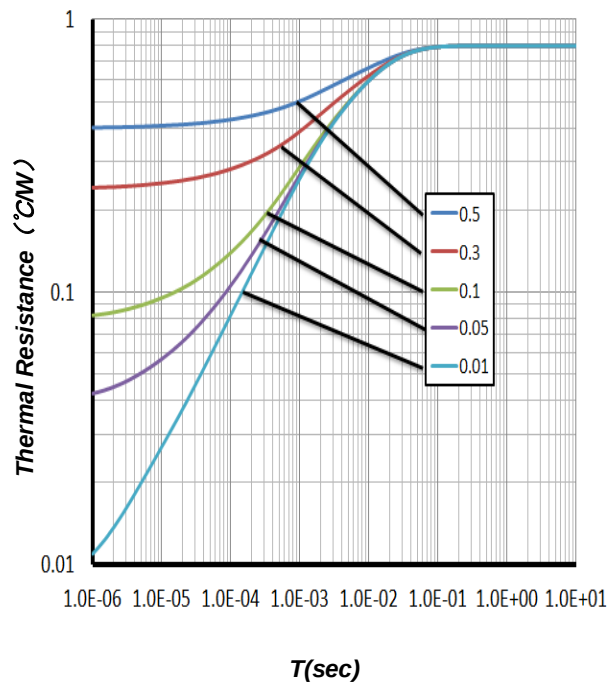
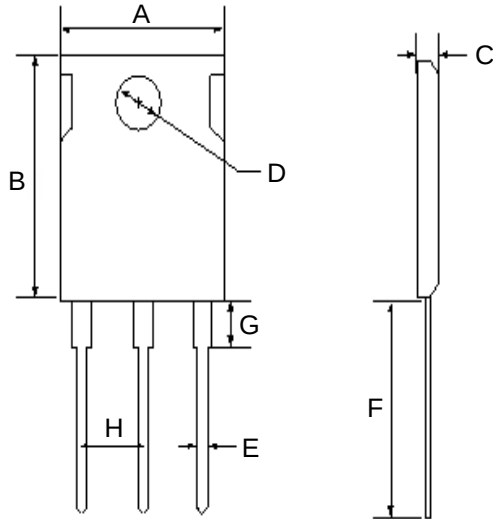


Figure 6. Transient Thermal Impedance

Package Dimensions

Package TO-247-3



Symbol	Min. (mm)	Typ. (mm)	Max. (mm)
A	14.18	15.75	17.33
B	18.45	20.5	22.55
C	4.50	5.00	5.50
D	3.15	3.50	3.85
E	1.08	1.20	1.32
F	18.27	20.30	22.33
G	4.21	4.68	5.15
H	4.91	5.46	6.01